



## Selected Papers from the 9th International Conference on Mechanical Engineering and Automation Science (ICMEAS 2023)

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### Message from the Guest Editors

Dear Colleagues,

This Special Issue will publish selected papers the 9th International Conference on Mechanical Engineering and Automation Science (ICMEAS 2023), Oct. 13-15, 2023, in Xi'an, China.

We aim to collect high-quality research papers and review articles from ICMEAS, which focus on mechanical design, actuator/sensor, advanced manufacturing, automation method & technology, robotic system, and related cutting-edge multidisciplinary fields. The conference will cover the following main topics:

- Digital design and topology optimization
- Functional surface interface technology
- Mechanical system dynamics and fault diagnosis techniques
- Advanced manufacturing method
- Artificial intelligence technology
- Micro and nano systems and applications
- Soft and medical robot
- Smart and active materials
- Intelligent measurement technology
- Indiscipline study of mechanical and electrical engineering





## Editor-in-Chief

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